

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at www.onsemi.com

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild guestions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officer



March 2013

FSA859 — Dual-Voltage, 0.8Ω SPDT Analog Switch with Power-Off Isolation

Features

- Power-Off Isolation (V_{CC=}0V)
- 0.8Ω Maximum On Resistance (R_{ON}) for 4.5V V_{CC}
- 0.25Ω Maximum R_{ON} Flatness for 4.5V V_{CC}
- Broad V_{CC} Operating Range: 1.65V to 5.5V
- Fast Turn-On and Turn-Off Times
- Control Input Referenced to V_{IO}
- Break-Before-Make Enable Circuitry
- 0.5mm WLCSP packaging
- ESD Performance
 - HBM: JESD22-A114, I/O to GND 8kV
 - CDM: JESD22-C101

500V

IEC61000-4-2 Contact / Air 8kV / 15kV

Description The ESA859 is

The FSA859 is a high-performance Single-Pole / Double-Throw (SPDT) analog switch for audio applications driven by low voltage (1.8V) baseband processors or ASICs. The device features ultra-low R_{ON} of 0.8Ω (maximum) at 4.5V V_{CC} and operates over the wide V_{CC} range of 1.65V to 5.5V. The device is fabricated with sub-micron CMOS technology to achieve fast switching speeds and is designed for break-before-make operation.

The FSA859 interfaces between the low-voltage ASIC and regular audio amplifiers and CODECs operating up to the supply range of 5.5V through the dual-voltage supplies of V_{IO} and V_{CC} . The V_{IO} supply operates the control circuitry, allowing for 1.8V (typical) signals on the control pin (Sel).

Applications

- Cellular Phone
- Portable Media Player
- PDA

IMPORTANT NOTE:

For additional performance information, please contact analogswitch@fairchildsemi.com.

Ordering Information

Part Number	Operating Temperature Range	Top Mark	Eco Status	Package	Packing Method
FSA859UCX	-40°C to +85°C	N2	Green	8-Ball WLCSP, 0.5mm pitch	Tape and Reel

Por Fairchild's definition of "green" Eco Status, please visit: http://www.fairchildsemi.com/company/green/rohs_green.html.

Analog Symbols

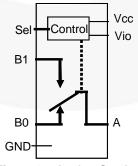
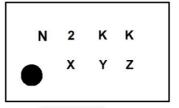


Figure 1. Analog Symbol

Marking Information



KK = Lot Run Code

X = Year

Y = Work Week Z = Assembly Site

Figure 2. Top Mark with Pin 1 Orientation

Pin Configuration

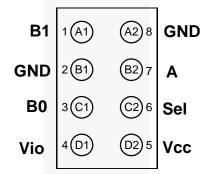


Figure 3. Pin Assignments (Top Through View)

Pin Definitions

Pin	Ball	Name	Description	
1	A1	B1	Data Port (Normally Open)	
2	B1	GND	Ground	
3	C1	В0	Data Ports (Normally Closed)	
4	D1	V_{IO}	Digital Control Supply	
5	D2	V_{CC}	Supply Voltage	
6	C2	Sel	Control Input	
7	B2	Α	Common Data Port	
8	A2	GND	Ground	

Truth Table

Control Input (Sel)	Function
LOW	B0 connected to A
HIGH	B1 connected to A

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Min.	Max.	Unit
V _{CC}	Supply Voltage	-0.5	6.5	V	
V _{IO}	Digital Control Supply Voltage		-0.5	6.5	V
V _{sw}	Switch Voltage ⁽¹⁾		-0.5	V _{CC} + 0.5	V
V _{IN}	Input Voltage ⁽¹⁾		-0.5	6.5	V
I _{IK}	Input Diode Current			-50	mA
I _{SW}	Switch Current (Continuous)			200	mA
I _{SWPEAK}	Peak Switch Current Pulsed at 1ms Duration,	<10% Duty Cycle		400	mA
P _D	Power Dissipation at 85°C			180	mW
T _{STG}	Storage Temperature Range		-65	+150	°C
TJ	Maximum Junction Temperature	1		+150	°C
TL	Lead Temperature (Soldering, 10 seconds)		\	+260	°C
	Human Body Model (JEDEC: JESD22 A444)	I/O to GND: A		8	kV
	Human Body Model (JEDEC: JESD22-A114)	All Pins		2	KV
ESD	Charged Device Model (JEDEC: JESD22-C101)			500	V
E3D	Machine Model (JEDEC: JESD22-A115)		N.	100	V
	IEC6100-4-2 Discharge system test performed on	Contact		8	kV
	Fairchild's FSA859 applications testing board	Air		15	KV

Note:

1. The input and output negative ratings may be exceeded if the input and output diode current ratings are observed.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
V _{CC}	Supply Voltage	1.65	5.50	V
V _{IO}	Digital Control Supply	1.65	1.95	V
Sel	Control Input Voltage ⁽²⁾	0	V _{IO}	V
V_{SW}	Switch Input Voltage	0	V _{CC}	V
T _A	Operating Temperature	-40	+85	°C
$\theta_{\sf JA}$	Thermal Resistance, Still Air		350	°C/W

Note:

2. Control Input must be held HIGH or LOW; it must not float.

Electrical Characteristics

All typical values are at 25°C unless otherwise specified. V_{IO} =1.65 to 1.95V.

	mb al Danamatan		(V) Conditions		T _A =+25°C			T _A =-40 to +85°C		
Symbol	Parameter	V _{cc} (V)	Conditions	Min.	Тур.	Max.	Min.	Max.	Unit	
V _{IHIO}	Input Voltage High - V _{IO}	1.95 to 5.50					0.65•V _{IO}	V _{IO}	V	
V _{ILIO}	Input Voltage Low - V _{IO}	1.95 to 5.50					0	0.35•V _{IO}	٧	
I _{IN}	Control Input Leakage	1.95 to 5.50	V _{Sel} =0 or V _{IO}	-2		2	-20	20	nA	
		5.50	A=1V,4.5V B0 or B1=4.5, 1V	-10		10	-50	50		
I _{NO(0FF),}	Off-Leakage Current	3.60	A=1V,3.0V B0 or B1=3.0, 1V	-10		10	-50	50		
I _{NC(OFF)} ,	of Port B0 and B1 (6)	2.70	A=0.5V,2.3V B0 or B1=2.3, 0.5V	-10	- 7	10	-50	50	nA	
		1.95	A=0.3V,1.65V B0 or B1=1.65 ,0.3 V	-5	1	5	-20	20		
	I _{NO(On)} , On-Leakage Current of Port B0 and B1 ⁽⁶⁾	5.50	A=float B0 or B1=4.5, 1V	-20		20	-100	100		
NO(On)		3.60	A=float B0 or B1=3.0, 1V	-10		10	-20	20		
		2.70	A=float B0 or B1=2.3, 0.5V	-10		10	-20	20	nA	
		1.95	A=float B0 or B1=1.65, 0.3V	-5		5	-20	20		
		5.50	A=1V,4.5V; B0 or B1=1V, 4.5V or floating	-20		20	-100	100		
		3.60	A=1V, 3.0VB0 or B1=1V, 3.0V or floating	-10		10	-20	20		
I _{A(ON)}	On Leakage Current of Port A (6)	2.70	A=0.5V, 2.3V, B0 or B1=0.5V, 2.3V, or floating	-10		10	-20	20	nA	
		1.95	A=0.3V, 1.65V; B0 or B1=0.3V, 1.65V, or floating	-5		5	-20	20		
I _{OFF}	Power Off Leakage Current of Port A & Port B ⁽⁶⁾	0	A=0 to 5.5V B0 or B1=0 to 5.5V	-1.00	0.01	1.00	-5.00	5.00	μΑ	
		5.50	V _{IN} =0 or V _{CC} , I _{OUT} =0		10	50		500		
	Quiescent Supply	3.60	V _{IN} =0 or V _{CC} , I _{OUT} =0		1.0	25.0		100.0	~ Λ	
I _{CC}	Current	2.70	V _{IN} =0 or V _{CC} , I _{OUT} =0		0.5	20.0		50.0	nA	
		1.95	V _{IN} =0 or V _{CC} , I _{OUT} =0		0.5	15.0		50.0	3	

Continued on the following page...

Electrical Characteristics (Continued)

All typical values are at 25°C unless otherwise specified. V_{IO} =1.65 to 1.95V.

Symbol	Parameter	V 00	Canditions	•	Γ _A =+25°(3	T _A =-40 t	o +85°C	Unit
Symbol	Parameter	V _{cc} (V)	Conditions	Min.	Тур.	Max.	Min.	Max.	Unit
		4.50	I _{OUT} =-100mA, B0 or B1=2.5V		0.50	0.75		0.80	
В	Switch On	3.00	I _{OUT} =-100mA, B0 or B1=2.0V		0.75	0.90		1.2	_
R _{on}	Resistance ^(3,6)	2.25	I _{OUT} =-100mA, B0 or B1=1.8V		1.0	1.3		1.6	Ω
		1.65	I _{OUT} =-100mA, B0 or B1=1.2V		2.5	5.0		7.0	
		4.50 I _{OUT} =-100mA, B0 or B1=2.5V 0.05 0.10		0.10					
ΔRon	On Resistance Matching	3.00	I _{OUT} =-100mA, B0 or B1=2.0V		0.10	0.15		0.15	Ω
ΔKON	Between Channels ^(4,6)	2.25	I _{OUT} =-100mA, B0 or B1=1.8V		0.15	0.20		0.20	12
		1.65	I _{OUT} =-100mA, B0 or B1=1.2V		0.15	0.40		0.40	
		4.50	I _{OUT} =-100mA, B0 or B1=1.0V, 1.5V, 2.5V		0.075	0.250		0.250	
D	On Resistance	3.00	I _{OUT} =-100mA, B0 or B1=0.8V, 2.0V		0.1	0.3		0.3	Ω
R _{FLAT(ON)}	Flatness ^(5,6)	2.25	I _{OUT} =-100mA, B0 or B1=0.8V, 1.8V		0.25	0.50		0.6	72
		1.65	I _{OUT} =-100mA, B0 or B1=0.6V, 1.2V		3.5				

Notes:

- 3. On resistance is determined by the voltage drop between A and B pins at the indicated current through the switch.
- 4. Δ R_{ON}=R_{ON} maximum R_{ON} minimum measured at identical V_{CC}, temperature, and voltage.
- Flatness is defined as the difference between the maximum and minimum value of on resistance over the specified range of conditions.
- 6. Guaranteed by characterization, not production tested for V_{CC} =1.65 1.95V.

AC Electrical Characteristics

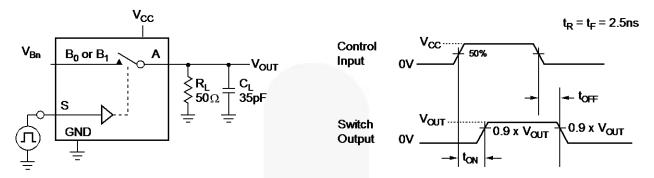
All typical value are at V_{IO} =1.8V and V_{CC} =1.8V, 2.5V, 3.0V, and 5.0V at 25°C unless otherwise specified.

		.,			T _A =+25°C		T _A =-40 t	o +85ºC		Figure
Symbol	Symbol Parameter V _{CC} (V)	Conditions	Min.	Тур.	Max.	Min.	Max.	Unit		
		4.50 to 5.50		1.0	12.0	25.0	1.0	30.0		
	(6)	3.00 to 3.60	B0 or B1=V _{CC} ,	5.0	15.0	30.0	3.0	35.0		
t _{ON}	Turn-On Time ⁽⁶⁾	2.30 to 2.70	R_L =50 Ω , C_L =35pF	5.0	20.0	35.0	5.0	40.0	ns	Figure 4
		1.65 to 1.95		10.0	50.0	70.0	10.0	75.0	=	
		4.50 to 5.50		1.0	9.5	20.0	1.0	25.0		
		3.00 to 3.60	B0 or B1=V _{CC} ,	1.0	9.0	20.0	1.0	25.0		
t _{OFF}	Turn-Off Time ⁽⁶⁾	2.30 to 2.70	R _L =50Ω, C _L =35pF	2.0	10.0	20.0	2.0	25.0	ns	Figure 4
	/	1.65 to 1.95		2.0	28.0	40.0	2.0	50.0		
		4.50 to 5.50		1.0	10.0	12.0	0.1	14.0		
	Break-Before-	3.00 to 3.60	B0 or B1= V_{CC} , R_L =50 Ω , C_L =35pF	1.0	14.0	16.0	1.0	17.0	- ns	Figure 5
t _{BBM}	Make Time ⁽⁶⁾	2.30 to 2.70		1.0	21.0	25.0	1.0	27.0		
		1.65 to 1.95			35.0		2.0	50.0		N.
		5.50			47					
0	Oh a man hair atian	3.30	C _L =1.0nF,		33		\ \		pC	
Q	Charge Injection	2.50	$V_{GEN}=0V,$ $R_{GEN}=0\Omega$		23		1	11		Figure 7
		1.65			10					
OIRR	Off Isolation	1.8 to 5.0	f=1MHz, R _L =50Ω		-60				dB	Figure 6
Xtalk	Crosstalk	1.8 to 5.0	f=1MHz, R _L =50Ω		55				dB	Figure 6
		5.50			60					
DW	2db Doodwidth	3.30	D -500		60		1	1	NAL I-	Figure 9
DVV	BW -3db Bandwidth -	2.50	R _L =50Ω		55				MHz	
		1.65			50					
THD	Total Harmonic Distortion	1.80	$R_L=600\Omega, V_{IN}=0.5V_{PP},$.015		1		%	Figure 10
	ווטוווטוו	5.00	f=20Hz to 20kHz		.002					

Capacitance

Cumbal	Symbol Devemeter		Conditions	T _{A=} +25°C			Unit
Symbol	Symbol Parameter	V _{cc} (V)	Conditions	Min.	Тур.	Max.	Unit
C _{IN}	Control Pin Input Capacitance	0	f=1MHz		3.2		pF
C_{OFF}	B Port Off Capacitance	1.65 to 5.50	f=1MHz		50		pF
Con	A Port On Capacitance	1.65 to 5.50	f=1MHz		150		pF

Test Diagrams



C_L includes fixture and stray capacitance.

Logic input waveforms inverted for switches that have the opposite logic sense.

Figure 4. Turn On / Off Timing

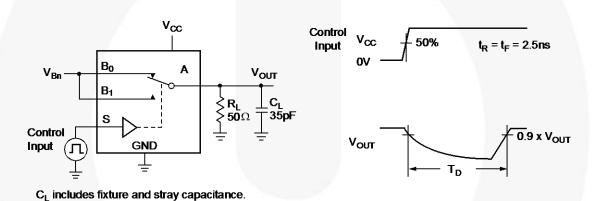


Figure 5. Break-Before-Make Timing

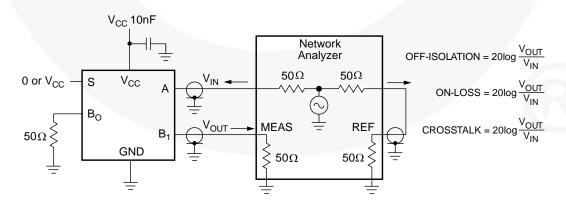


Figure 6. Off Isolation and Crosstalk

Test Diagrams (Continued)

Figure 7. Charge Injection

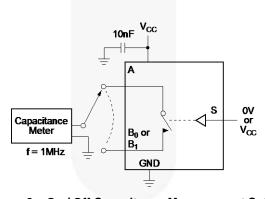


Figure 8. On / Off Capacitance Measurement Setup

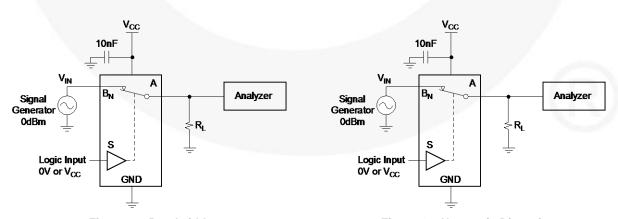
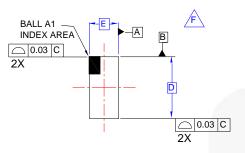


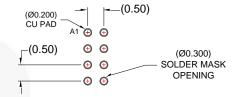
Figure 9. Bandwidth

Figure 10. Harmonic Distortion

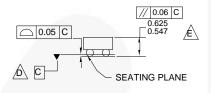
Physical Dimensions



TOP VIEW

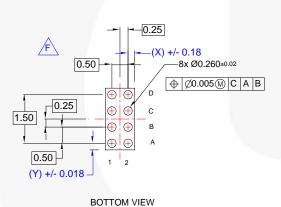


RECOMMENDED LAND PATTERN (NSMD)



SIDE VIEWS





NOTES:

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCE PER ASMEY14.5M, 1994.
- DATUM C, THE SEATING PLANE IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.
- PACKAGE NOMINAL HEIGHT IS 586 MICRONS ±39 MICRONS (547-625 MICRONS).
- FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.
- G. BALL COMPOSITION: Sn95.5Ag3.9Cu0.6
- H. DRAWING FILNAME: MKT-UC008ADrev2

Figure 11. 8-Ball, WLCSP 0.5mm Pitch

Table 1. Product Specific Dimensions

Product	D	E	X	Υ
FSA859UCX	1.910	0.910	0.205	0.205

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/packaging/





TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

Build it Now™ Core PLUS™ Core POWER™ CROSSVOLT** CTL™ Current Transfer Logic™ **EcoSPARK** EfficentMa×™ EZSWITCH™*

Fairchild® Fairchild Semiconductor® FACT Quiet Series™ FACT® FAST® FastvCore™ FlashWriter®

F-PESTM FRFET® Global Power Resource Green FPS™ Green FPS™ e-Series™ GTO** IntelliMAX™ ISOPLANAR™ MegaBuck™ MICROCOUPLER™ MicroFET™ MicroPak™

MillerDrive™ MotionMa×™ Motion-SPM™ OPTOLOGIC® OPTOPLANAR® PDP SPM™ Power-SPM™ PowerTrench® Programmable Active Droop™ OFFT

OSTM Quiet Series™ RapidConfigure™ Saving our world, 1mVV at a time™ SmartMax™ SMART START™ SPM® STEALTH™ SuperFET™ SuperSOT**-3 SuperSOTM6 SuperSOT*8 SupreMOS™ SyncFET™

SYSTEM &

The Power Franchise® Wer franchise TinyBoost™ TinyBuck™ TinyLogic[©] TINYOPTO** TinyPower** TinyPVVM™ TinyWire™ uSerDes™ UHC Ultra FRFET™

UniFET™ **VCXTM** VisualMax™

* EZSWITCH™ and FlashWriter® are trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HERBIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THERBIN, WHICH COVERS THESE PRODUCTS

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Source's Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition		
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
Obsolete Not In Production		Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor datasheet is for reference information only.		

Rev. 135

ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdt/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor and see any inability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and ex

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800-282-9855 Toll Free USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative